

ALTERNISTORS

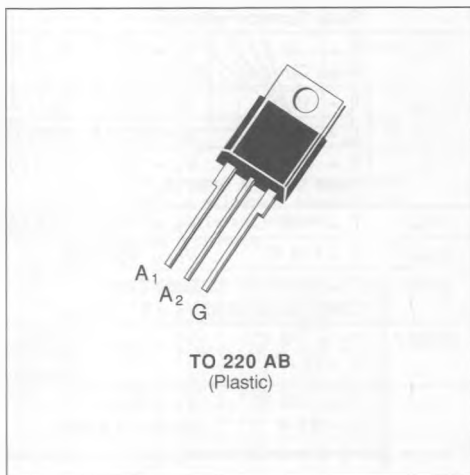
- $(di/dt)_c > 42.5$ A/ms (400 Hz)
- INSULATING VOLTAGE : 2500 V_{RMS}
($t \leq 1$ mn - F = 50 Hz)
- UL RECOGNIZED (E81734)

APPLICATIONS

- POWER CONTROL ON INDUCTIVE LOAD
(motor, transformer...)
- HIGH FREQUENCY OR HIGH $(di/dt)_c$ LEVEL
CIRCUITS

DESCRIPTION

New range of solid state AC - switches with very high commutating capability.


ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state Current (360° conduction angle)	$T_C = 75$ °C	12	A
I_{TSM}	Non Repetitive Surge Peak on-state Current	$t = 10$ ms	120	A
		$t = 8.3$ ms	125	
		$t = 2.5$ ms	170	
I^2t	I^2t Value for Fusing	$t = 10$ ms	72	A ² s
di/dt	Critical Rate of Rise of on-state Current (1)		100	A/ μ s
T_{stg} T_j	Storage and Operating Junction Temperature Range		- 40 to 150 - 40 to 110	°C °C

Symbol	Parameter	TXDV				Unit
		212	412	612	812	
V_{DRM}	Repetitive Peak off-state Voltage (2)	200	400	600	800	V

- (1) $I_G = 1$ A $di/dt = 1$ A/ μ s
 (2) $T_j = 110$ °C.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to Ambient	60	°C/W
$R_{th(j-c)}$ DC	Junction to Case for DC	2.5	°C/W
$R_{th(j-c)}$ AC	Junction to Case for 360° Conduction Angle (F = 50 Hz)	1.85	°C/W

GATE CHARACTERISTICS (maximum values)

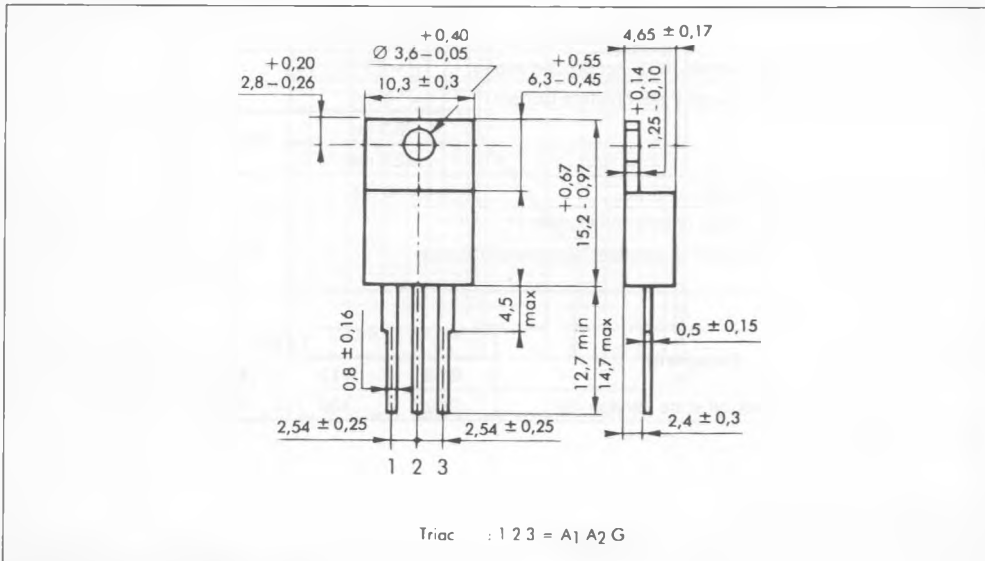
$P_{GM} = 40 \text{ W}$ ($t_p = 10 \mu\text{s}$) $I_{GM} = 4 \text{ A}$ ($t_p = 10 \mu\text{s}$)
 $P_{G(AV)} = 1 \text{ W}$ $V_{GM} = 16 \text{ V}$ ($t_p = 10 \mu\text{s}$)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ Pulse Duration $> 20 \mu\text{s}$	I-II-III			100	mA
V_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ Pulse Duration $> 20 \mu\text{s}$	I-II-III			1.5	V
V_{GD}	$T_j = 110 \text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$	I-II-III	0.2			V
I_H^*	$T_j = 25 \text{ }^\circ\text{C}$ $I_T = 500 \text{ mA}$ Gate Open				100	mA
I_L	$T_j = 25 \text{ }^\circ\text{C}$ $V_D = 12 \text{ V}$ $I_G = 200 \text{ mA}$ Pulse Duration $> 20 \mu\text{s}$	I-III		100		mA
		II		200		
V_{TM}^*	$T_j = 25 \text{ }^\circ\text{C}$ $I_{TM} = 17 \text{ A}$ $t_p = 10 \text{ ms}$				1.95	V
I_{DRM}^*	$T_j = 110 \text{ }^\circ\text{C}$ V_{DRM} Specified				2	mA
dv/dt^*	$T_j = 110 \text{ }^\circ\text{C}$ Gate Open Linear Slope up to $V_D = 67 \% V_{DRM}$		500			V/ μs
$(di/dt)_c^*$	$T_C = 75 \text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 17 \text{ A}$	$(dv/dt)_c = 200 \text{ V}/\mu\text{s}$	10			A/ms
		$(dv/dt)_c = 10 \text{ V}/\mu\text{s}$	42.5			
t_{gI}	$T_j = 25 \text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 17 \text{ A}$ $I_G = 0.5 \text{ A}$ $di_G/dt = 3.5 \text{ A}/\mu\text{s}$	I-II-III		2.5		μs

* For either polarity of electrode A_2 voltage with reference to electrode A_1 .

PACKAGE MECHANICAL DATA : TO 220 AB Plastic



Cooling method : by conduction (method C)
 Marking : type number
 Weight : 2 g

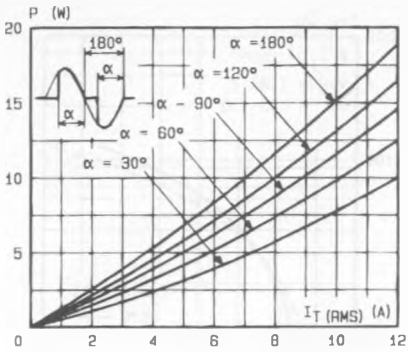


Fig.1 - Maximum mean power dissipation versus RMS on-state current

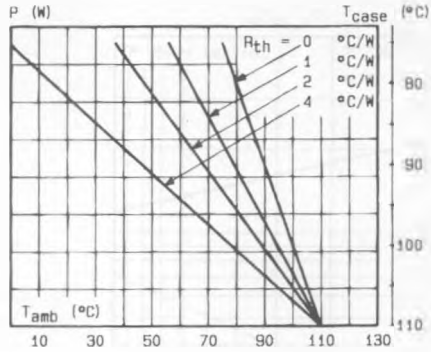


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

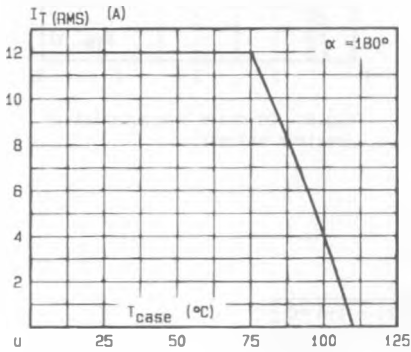


Fig.3 - RMS on-state current versus case temperature.

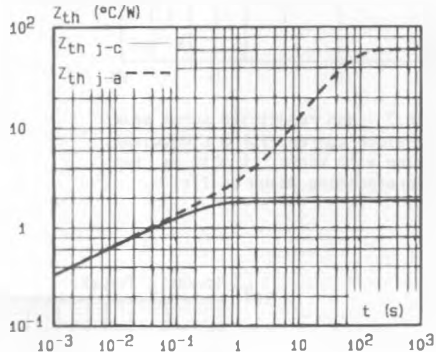


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

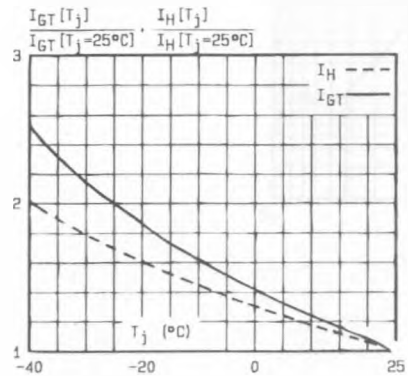


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

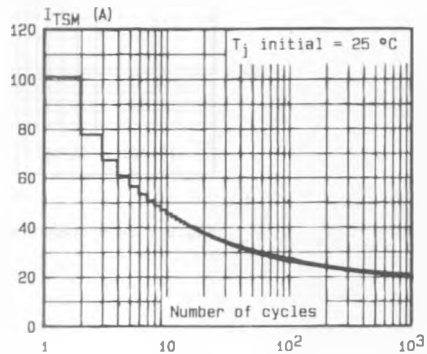


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

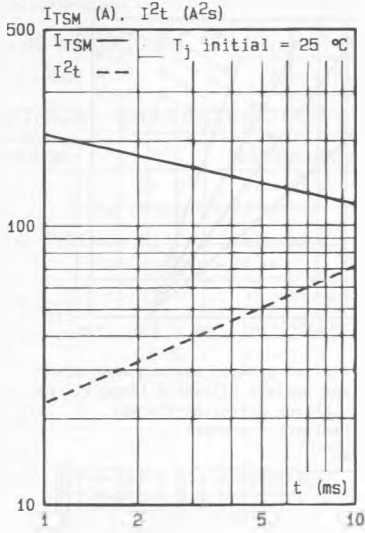


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

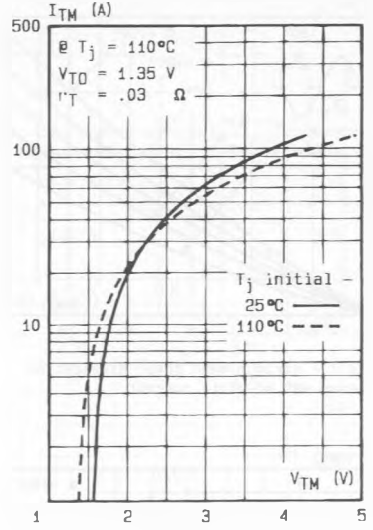


Fig.8 - On-state characteristics (maximum values).

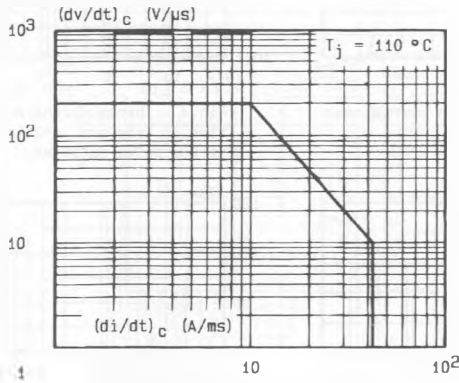


Fig.9 - Safe operating area.